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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/605,449	09/30/2003	Dennis R. Conti	BUR920030050US1	2448

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EXAMINER

HOLLINGTON, JERMELE M

ART UNIT	PAPER NUMBER
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2829

DATE MAILED: 04/03/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/605,449

Applicant(s)

CONTI ET AL.

Examiner

Jermele M. Hollington

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 12 January 2006.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-12 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-12 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Response to Arguments

1. Applicant's arguments, see page 5 as well as Declaration under 37 C.F.R. 1.132, filed on Jan. 12, 2006, with respect to the rejection(s) of claim(s) under 35 USC 102(e) have been fully considered and are persuasive. Therefore, the rejection has been withdrawn. However, upon further consideration, a new ground(s) of rejection is made in view of Hamilton and Iino et al.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

3. Claims 1-4 and 7-10 are rejected under 35 U.S.C. 102(b) as being anticipated by Iino et al (5568054).

Regarding claims 1-2, Iino et al disclose [see Fig. 6] controlling the burning in of at least one I/C chip (IC chip on wafer W) in a burn in tool (inspection section 12), wherein said tool (12) has a device (probe card 20) for mounting each chip (IC on wafer W) to be burned in, and a power source (power source 40) to supply electrical current to burn in each chip (IC on wafer W), comprising the steps of: continuously monitoring [via measuring section 41] at least one electrical value input to each chip (on wafer W) wherein the current value is maintain at or below a given value [see col. 2, lines 9-30, col. 5, lines 3-63, col. 6, lines 29-37 and col. 7, line 47-col. 8, line 13].

Regarding claim 3, Iino et al disclose [see Fig. 6] at least one electrical value input to each chip (on wafer W) wherein the power value is maintain at or below a given value [see col. 2, lines 9-30, col. 5, lines 3-63, col. 6, lines 29-37 and col. 7, line 47-col. 8, line 13].

Regarding claim 4, Iino et al disclose each device temperature is monitored [via measuring section 41] and the voltage to each device (20) is varied to maintain the device temperature [see col. 2, lines 9-30, col. 5, lines 3-63, col. 6, lines 29-37 and col. 7, line 47-col. 8, line 13].

Regarding claims 7-8, Iino et al disclose [see Fig. 6] controlling the burning in of at least one I/C chip (IC chip on wafer W) in a burn in tool (inspection section 12), wherein said tool (12) has a device (probe card 20) for mounting each chip (IC on wafer W) to be burned in, and a power source (power source 40) to supply electrical current to burn in each chip (IC on wafer W), comprising the steps of: continuously monitoring [via measuring section 41] at least one electrical value input to each chip (on wafer W) wherein the current value is maintain at or below a given value [see col. 2, lines 9-30, col. 5, lines 3-63, col. 6, lines 29-37 and col. 7, line 47-col. 8, line 13].

Regarding claim 9, Iino et al disclose [see Fig. 6] at least one electrical value input to each chip (on wafer W) wherein the power value is maintain at or below a given value [see col. 2, lines 9-30, col. 5, lines 3-63, col. 6, lines 29-37 and col. 7, line 47-col. 8, line 13].

Regarding claim 10, Iino et al disclose a monitor (measuring section 41) to continuously monitor the temperature value of each chip (W) being burned in and wherein the voltage is varied to maintain the temperature value of each device at a given value [see col. 2, lines 9-30, col. 5, lines 3-63, col. 6, lines 29-37 and col. 7, line 47-col. 8, line 13].

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4. Claims 1,4-7, and 10-12 are rejected under 35 U.S.C. 102(b) as being anticipated by Hamilton (5911897).

Regarding claim 1, Hamilton discloses [see Figs. 1-2] a method of controlling the burning in of at least one I/C chip (IC chip 12) in a burn in tool (burn-in board 10), wherein said tool (10) has a device (heat sink assembly 24) for mounting each chip (12) to be burned in, and a power source (V REF in Fig. 3) to supply electrical current to burn in each chip (12), comprising the steps of: continuously monitoring [via sensor housing 44] at least one electrical value input to each chip (12) selected from the group of current, voltage and power, and varying the voltage to maintain at least one of the values at or below a given value [see also col. 1, lines 45-56].

Regarding claim 4, Hamilton discloses each device temperature is monitored [via temperature sensor 48] and the voltage to each device is varied to maintain the device (24) at or below a given temperature.

Regarding claim 5, Hamilton discloses a heat sink (heat sink 34) in contact with the device (24).

Regarding claim 6, Hamilton discloses the device temperature of each device (24) is monitored [via temperature sensor 48] and the temperature of the heat sink (34) is varied to maintain the device temperature at a given value.

Regarding claim 7, Hamilton discloses a burn in tool (burn in board 10) for burning in at least one I/C chip (IC chip 12) comprising: a structure (heat sink assembly 24) for mounting each chip (12) to be burned in; a power source (V REF) to supply electrical current to burn in each chip (12); a structure (sensor housing 44) for continuously monitoring at least one electrical

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value input to each chip (12) selected from the group of current, voltage and power, and a structure to vary the voltage to maintain at least one of the values at or below a given value.

Regarding claim 10 Hamilton discloses a monitor (temperature sensor 48) to continuously monitor the temperature value of each chip (12) being burned in and wherein the voltage is varied to maintain the temperature value of each device at a given value.

Regarding claim 11, Hamilton discloses a heat sink (heat sink 34) is in contact with each device (24).

Regarding claim 12, Hamilton discloses the tool (10) has a heat sink (heat sink 34) and temperature monitor (48) for each device (24) and each heat sink (34) has means (48) to control the temperature of the heat sink (34), and the temperature control means (22) is varied to maintain the temperature value of each device (24) at a given value.

Conclusion

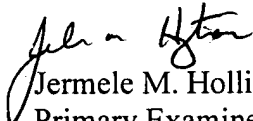
5. Applicant's arguments with respect to claims 1-12 have been considered but are moot in view of the new ground(s) of rejection.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jermele M. Hollington whose telephone number is (571) 272-1960. The examiner can normally be reached on M-F (9:00-4:30 EST) First Friday Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (517) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).


Jermele M. Hollington
Primary Examiner
Art Unit 2829

JMH
March 30, 2006